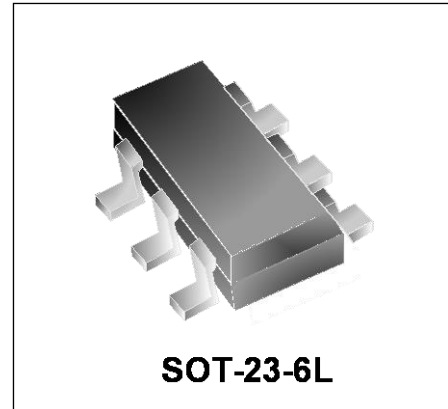


Transient Voltage Suppressor

Features

- Solid-state silicon-avalanche technology
- 300 Watts Peak Pulse Power per Line ($t_p=8/20\mu s$)
- Low operating and clamping voltages
- Up to Four (4) Lines of Protection
- Working Voltage: 5 V
- Low Leakage



IEC COMPATIBILITY (EN61000-4)

- IEC 61000-4-2 (ESD) $\pm 30kV$ (air), $\pm 30kV$ (contact)
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 20A (8/20 μs)

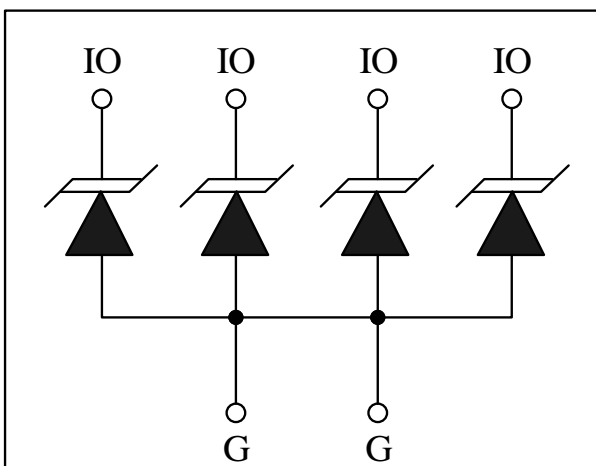
Mechanical Characteristics

- SOT-23-6L package
- Marking: Marking Code
- Packaging: Tape and Reel
- RoHS Compliant

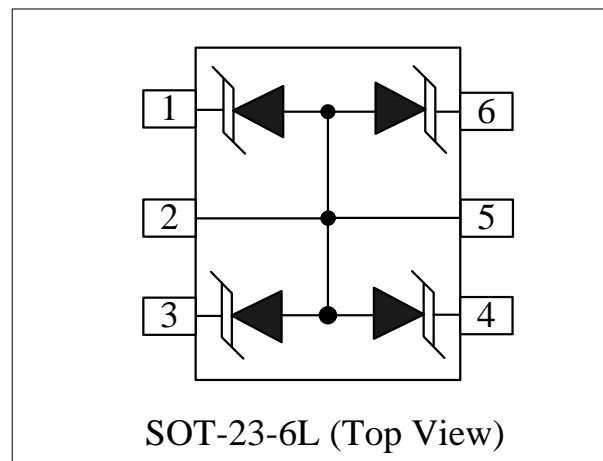
Applications

- Cell phone Handsets & Accessories
- Personal Digital Assistants (PDAs)
- Notebook, Laptop, and Palmtop Computers
- Portable Instrumentation
- Digital Cameras

Circuit Diagram



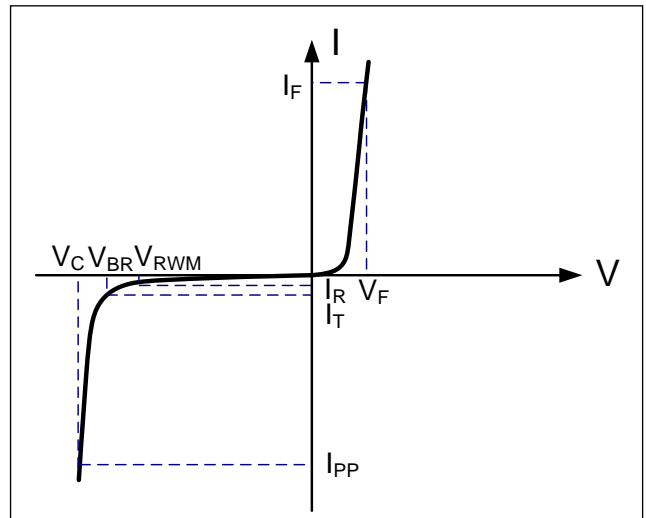
Schematic & PIN Configuration



Absolute Maximum Rating			
Rating	Symbol	Value	Units
Peak Pulse Power ($t_p = 8/20\mu s$)	P_{PP}	300	Watts
Peak Pulse Current ($t_p = 8/20\mu s$)	I_{PP}	20	A
Operating Temperature	T_J	-55 to +150	$^{\circ}C$
Storage Temperature	T_{STG}	-55 to +150	$^{\circ}C$

Electrical Parameters (T=25 $^{\circ}C$)

Symbol	Parameter
I_{PP}	Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Reverse Stand-Off Voltage
I_R	Reverse Leakage Current @ V_{RWM}
V_{BR}	Reverse Breakdown Voltage @ I_T
I_T	Test Current
I_F	Forward Current
V_F	Forward Voltage @ I_F



Electrical Characteristics

WS05MS						
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}	Any I/O pin to ground			5	V
Reverse Breakdown Voltage	V_{BR}	$I_T = 1mA$ Any I/O pin to ground	6		9	V
Reverse Leakage Current	I_R	$V_{RWM} = 5V, T = 25^{\circ}C$ Any I/O pin to ground			500	nA
Forward Voltage	V_F	$I_F = 10mA$	0.5		1.2	V
Clamping Voltage	V_C	$I_{PP} = 20A, t_p = 8/20\mu s$ Any I/O pin to ground		11.5	15	V
ESD Clamping Voltage ¹	V_C	$I_{PP} = 4A$ $t_p = 0.2/100ns$		7.9		V
ESD Clamping Voltage ¹	V_C	$I_{PP} = 16A$ $t_p = 0.2/100ns$		10.3		V
Dynamic Resistance ^{1,2}	R_{DYN}	TLP=0.2/100ns		0.2		Ω
Junction Capacitance	C_j	$V_R = 0V, f = 1MHz$ I/O pin to GND		165	200	pF
		$V_R = 0V, f = 1MHz$ Between I/O pins		80	120	pF

Note: 1、 TLP Setting : $t_p = 100ns, t_r = 0.2ns, I_{TLP}$ and V_{TLP} sample window: $t_1 = 70ns$ to $t_2 = 90ns$.
 2、 Dynamic resistance calculated from $I_{PP} = 4A$ to $I_{PP} = 16A$ using "Best Fit".

Typical Characteristics

Figure 1: Peak Pulse Power vs. Pulse Time

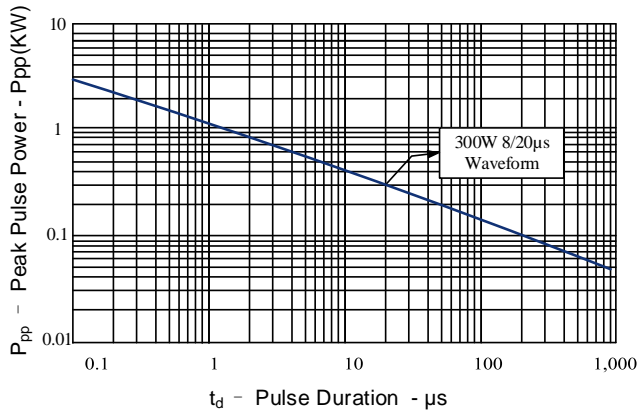


Figure 2: Power Derating Curve

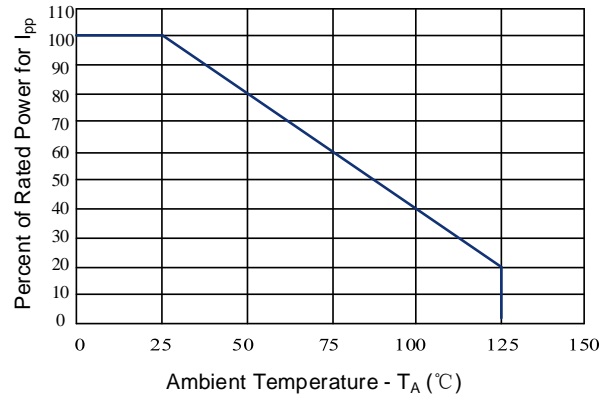


Figure 3: Clamping Voltage vs. Peak Pulse Current

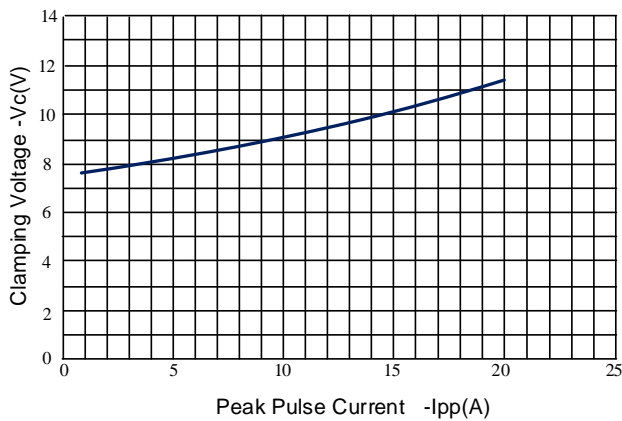


Figure 4: Normalized Junction Capacitance vs. Reverse Voltage

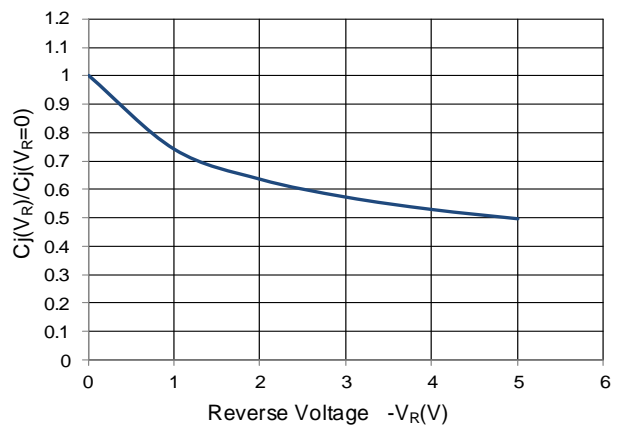


Figure 5: 8/20μs Pulse Waveform

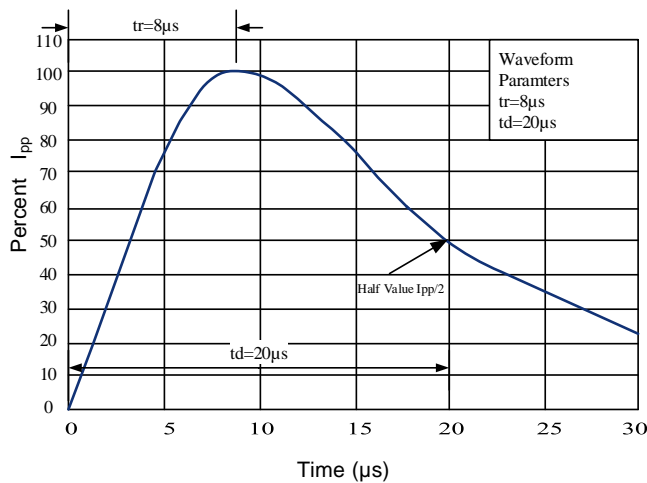
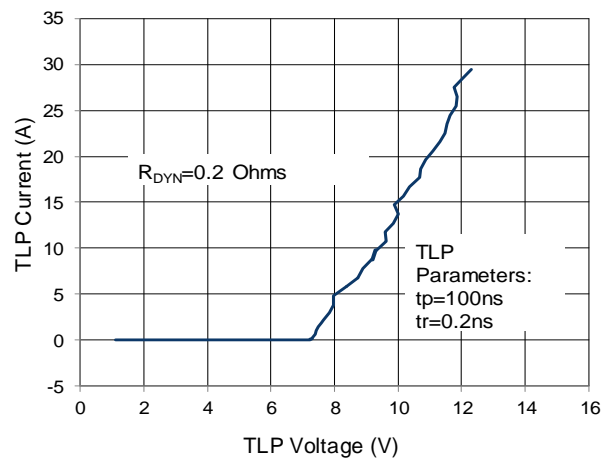
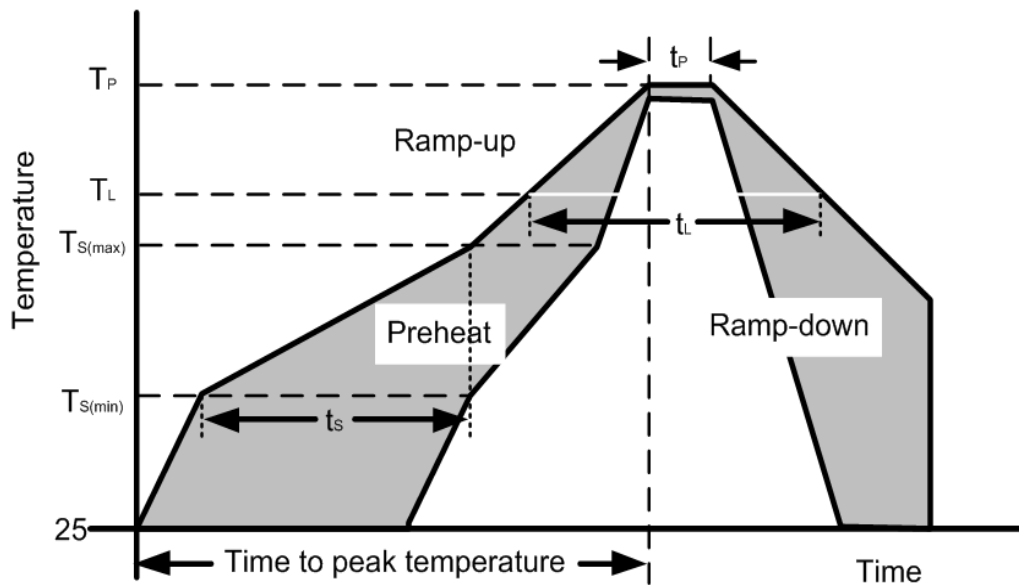


Figure 6: TLP I-V Curve



Soldering Parameters

Reflow Condition		Pb – Free assembly
Pre Heat	Temperature Min ($T_{S(min)}$)	150°C
	Temperature Max ($T_{S(max)}$)	200°C
	Time (min to max) (t_s)	60 – 190 secs
Average ramp up rate (Liquidus Temp) (T_L) to peak		5°C/second max
$T_{S(max)}$ to T_L —Ramp-up Rate		5°C/second max
Reflow	Temperature (T_L) (Liquidus)	217°C
	Temperature (t_L)	60 – 150 seconds
Peak Temperature (T_P)		260+0/-5 °C
Time within actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		5°C/second max
Time 25°C to peak Temperature (T_P)		8 minutes Max.
Do not exceed		280°C



Outline Drawing – SOT-23-6L

PACKAGE OUTLINE

SOT-23-6L

DIMENSIONS				
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.035	0.057	0.90	1.45
A1	0.000	0.006	0.00	0.15
A2	0.035	0.051	0.90	1.30
b	0.014	0.020	0.35	0.50
c	0.003	0.008	0.08	0.20
D	0.110	0.119	2.80	3.02
E1	0.060	0.069	1.50	1.75
E	0.102	0.118	2.60	3.00
e	0.037 BSC		0.95 BSC	
e1	0.075 BSC		1.90 BSC	
L	0.014	0.024	0.35	0.60
L1	0.022	0.030	0.55	0.75
θ 1	0°	8°	0°	8°
N	6		6	

DIMENSIONS		
DIM	INCHES	MILLIMETERS
C	0.098	2.50
G	0.055	1.40
P	0.037	0.95
X	0.024	0.60
Y	0.043	1.10
Z	0.141	3.60

Notes:

Controlling Dimension: Millimeter.

Marking Codes

Part Number	Marking Code
WS05MS	

Package Information

Qty: 3k/Reel

CONTACT INFORMATION

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 WAYON website: <http://www.way-on.com>
 For additional information, please contact your local Sales Representative.

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Specifications are subject to change without notice.
 The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.
 Users should verify actual device performance in their specific applications.